

N-Channel Silicon Carbide MOSFET

Rev.01 - 20 March 2023

Product data sheet

1. General description

Silicon Carbide MOSFET in a TO247-4L plastic package, designed for high frequency, high efficiency systems.

2. Features and benefits

- Separate driver source pin
- Low on-resistance
- Fast switching speed
- OV turn-off gate voltage for simple gate drive
- 100% UIS Tested
- Easy to parallel
- Controllable dV/dt for optimized EMI
- Reduced cooling requirements
- RoHS compliant

3. Applications

- Switch Mode Power Supplies
- UPS
- Solar string inverter and solar optimizer
- EV Charger
- Motor Drives

4. Quick reference data

able 1. Qu	lick reference data						
Symbol	Parameter	Conditions	Notes	Values		Unit	
Absolute	maximum rating						
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		1200		V	
I _D	drain current	V _{GS} = 18 V; T _{mb} = 25 °C			133		А
P _{tot}	total power dissipation	T _{mb} = 25 °C		750			W
Tj	junction temperature			-55 to 175		°C	
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics						
$R_{\text{DS(on)}}$	drain-source on-state resistance	V _{GS} = 15 V; I _D = 50 A; T _j = 25 °C		-	20	-	mΩ
Dynamic	characteristics						
Q _{G(tot)}	total gate charge	$I_{D} = 50 \text{ A}; V_{DS} = 800 \text{ V}; V_{GS} = 0 \text{ V}/18 \text{ V};$		-	215	-	nC
Q_{GD}	gate-drain charge	T _j = 25 °C		-	32	-	nC
Source-d	rain diode	·					
Q _r	recovered charge	I_{SD} = 50 A; di/dt = 500 A/µs; V _{DS} = 400 V; T _j = 25 °C		-	276	-	nC



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5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	D	drain		D
2	S	source		
3	SS	source sense		
4	G	gate		ss sym301 S
mb	D	mounting base; connected to drain		

6. Ordering information

Table 3. Ordering information								
Type number	Package	Orderable part number	Packing	Small packing	Package	Package		
	Name		method	quantity	version	issue date		
WNSC2M20120R	TO247-4L	WNSC2M20120R6Q	Tube	30	TO247N-4L	17-Dec-2021		

7. Marking

Table 4. Marking codes						
Type number	Marking codes					
WNSC2M20120R	WNSC2M 20120R					

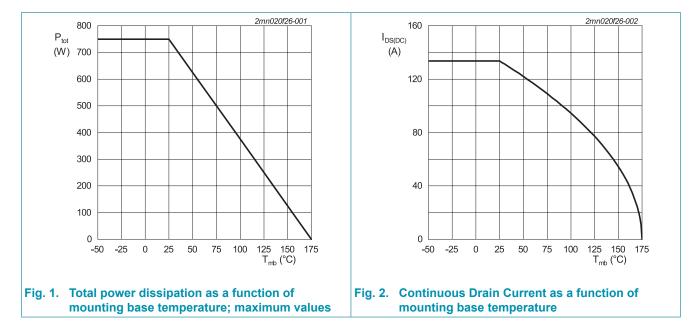
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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		1200	V
$V_{\text{GS,max}}$	gate-source voltage			-12 to 22	V
$V_{\text{GS,op}}$	gate-source voltage			-4 to 18	V
P _{tot}	total power dissipation	T _{mb} = 25 °C		750	W
I _D	drain current	V _{GS} = 18 V; T _{mb} = 25 °C		133	А
		V _{GS} = 18 V; T _{mb} = 100 °C		94	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$		200	А
E _{as}	single pulse drain-to- source avalanche	$I_{AS} = 30 \text{ A}; \text{ L} = 1 \text{ mH}; \text{ V}_{DD} = 100 \text{ V};$ $T_j = 25 \text{ °C}$		450	mJ
T _{stg}	storage temperature			-55 to 175	°C
T _j	junction temperature			-55 to 175	°C
T _{sld(M)}	peak soldering temperature			260	°C



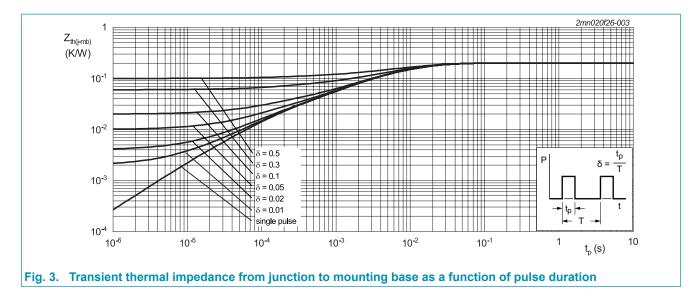
9. Thermal & Mechanical characteristics

Table 6. Thermal & Mechanical characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base			-	-	0.2	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air		-	40	-	K/W
M_{d}	Mounting torque	M3 or 6 - 32 screw		-	-	0.6	Nm

Note: It is recommended that a metal washer is inserted between screw head and mounting tab. Do not use self-tapping screws.

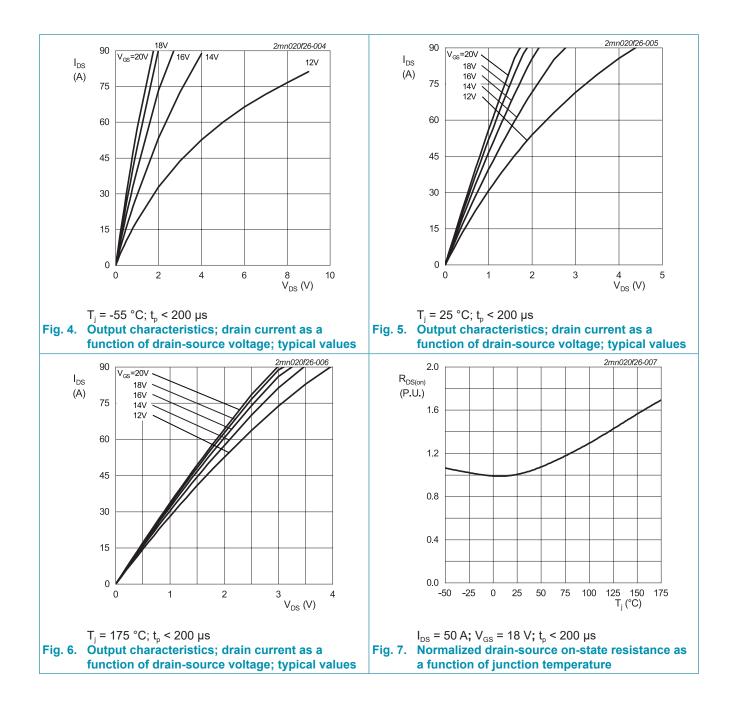
Device is ESD sensitive. Handling precautions are recommanded.

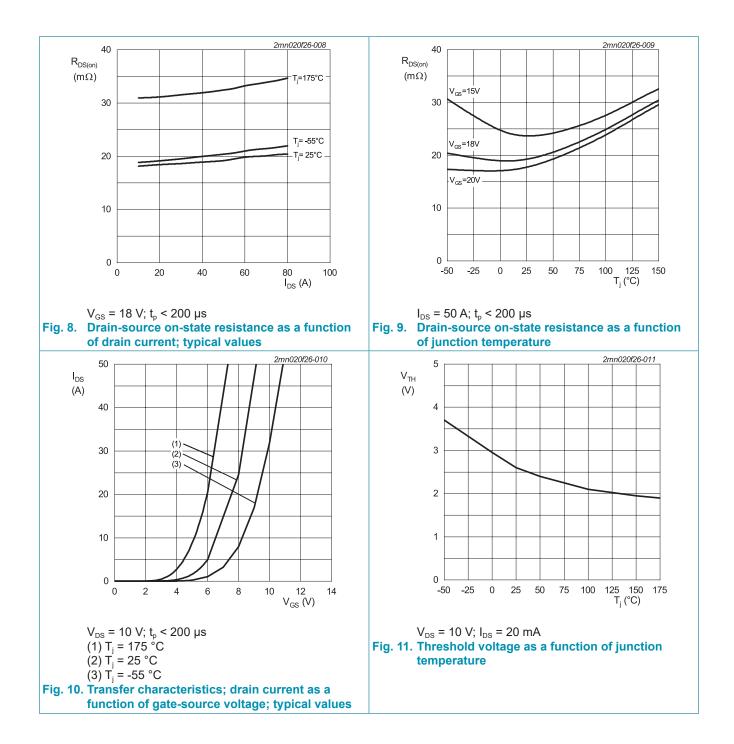


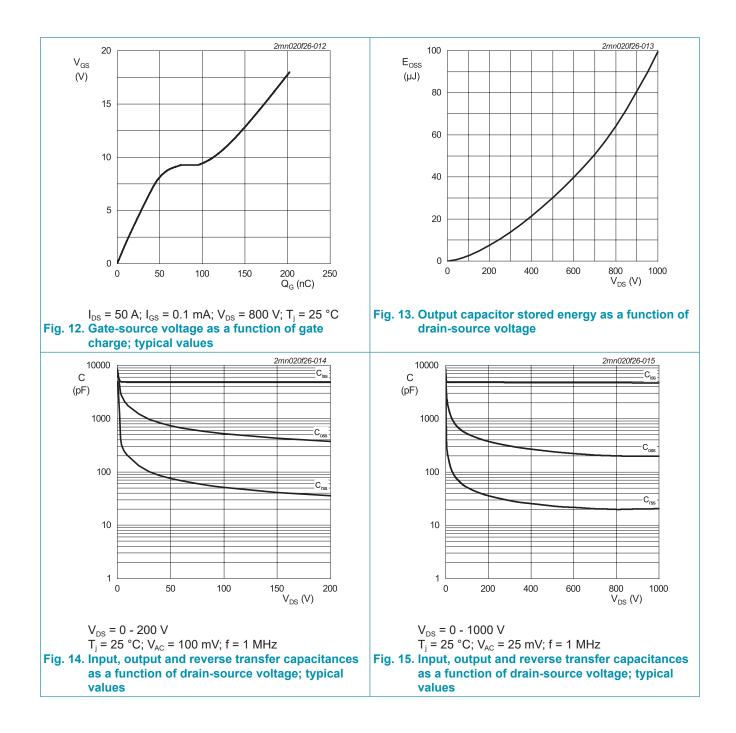
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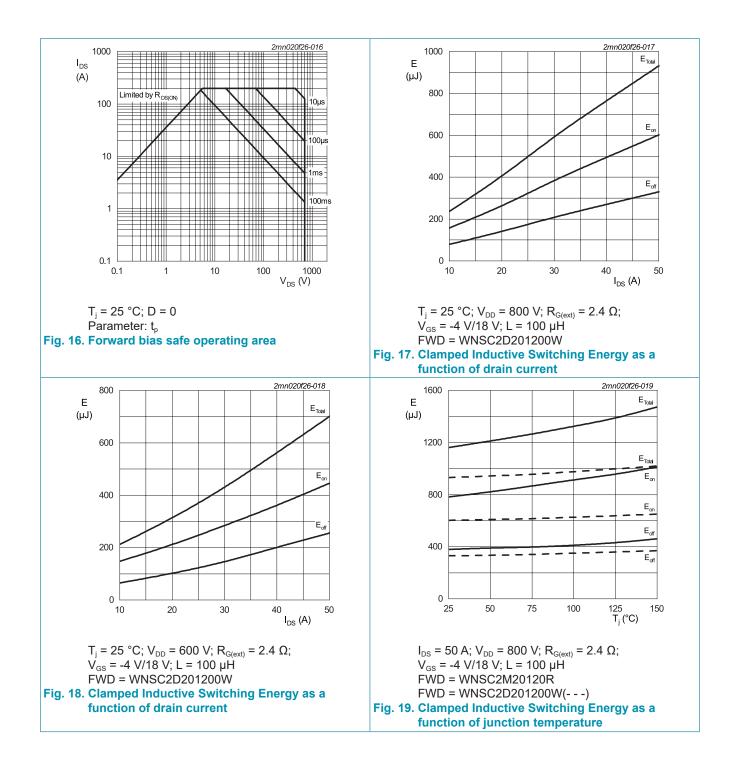
10. Characteristics

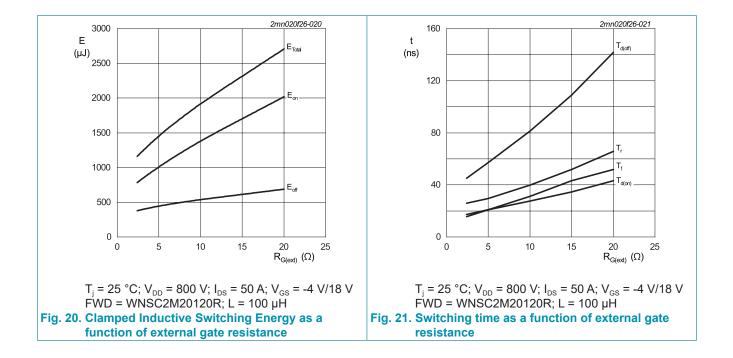
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
	aracteristics				- 71-		
V _{(BR)DSS}	drain-source breakdown voltage	I_{D} = 100 µA; V_{GS} = 0 V; T_{j} = 25 °C		1200	-	-	V
V _{GS(th)}	gate-source threshold	I _D = 20 mA; V _{DS} = 20 V; T _j = 25 °C		1.9	2.6	3.5	V
	voltage	I _D = 20 mA; V _{DS} = 20 V; T _j = 175 °C		-	1.9	-	V
I _{DSS}	drain leakage current	V_{DS} = 1200 V; V_{GS} = 0 V; T_j = 25 °C		-	0.5	100	μA
		V_{DS} = 1200 V; V_{GS} = 0 V; T_j = 175 °C		-	3	-	μA
I _{GSS}	gate leakage current	V_{GS} = 18 V; V_{DS} = 0 V; T_j = 25 °C		-	10	100	nA
		V _{GS} = -8 V; V _{DS} = 0 V; T _j = 25 °C		-	10	100	nA
R _{DS(on)}	drain-source on-state	V_{GS} = 15 V; I _D = 50 A; T _j = 25 °C		-	20	-	mΩ
	resistance	V_{gs} = 18 V; I_{D} = 50 A; T_{j} = 25 °C		-	17	23	mΩ
		V_{GS} = 18 V; I_{D} = 50 A; T_{j} = 175 °C		-	28	-	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C		-	0.6	-	Ω
$g_{\rm fs}$	transconductance	V _{DS} = 20 V; I _D = 50 A; T _j = 25 °C		-	31	-	S
Dynamic	characteristics						
Q _{G(tot)}	total gate charge	$I_{D} = 50 \text{ A}; V_{DS} = 800 \text{ V}; V_{GS} = 0 \text{ V}/18 \text{ V};$		-	215	-	nC
Q _{GS}	gate-source charge	T _j = 25 °C		-	83	-	nC
Q_{GD}	gate-drain charge			-	32	-	nC
C _{iss}	input capacitance	$V_{DS} = 1000 \text{ V}; V_{GS} = 0 \text{ V}; \text{ f} = 1 \text{ MHz};$		-	4701	-	pF
C _{oss}	output capacitance	T _j = 25 °C		-	199	-	pF
C _{rss}	reverse transfer capacitance			-	20	-	pF
E _{oss}	Coss stored energy			-	99.5	-	μJ
t _{d(on)}	turn-on delay time	$V_{DS} = 800 \text{ V}; V_{GS} = -4 \text{ V}/18 \text{ V}; R_{G(ext)} = 2.4$		-	17	-	ns
t _r	rise time	Ω; $I_D = 50$ A; L = 100 µH; $T_j = 25°°C$		-	26	-	ns
t _{d(off)}	turn-off delay time			-	45	-	ns
t _f	fall time			-	16	-	ns
E _{on}	turn-on energy (SiC Diode FWD)			-	601	-	μJ
E _{off}	turn-off energy (SiC Diode FWD)			-	330	-	μJ
E _{on}	turn-on energy (Body Diode FWD)			-	781	-	μJ
E _{off}	turn-off energy (Body Diode FWD)			-	380	-	μJ
Source-d	rain diode						
V _{SD}	source-drain voltage	V _{GS} = -4 V; I _F = 25 A; T _j = 25 °C		-	4.8	-	V
		V _{GS} = -4 V; I _F = 25 A; T _j = 175 °C		-	4.2	-	V
t _{rr}	reverse recovery time	$I_{sD} = 50 \text{ A}; \text{ di/dt} = 500 \text{ A/}\mu\text{s}; \text{ V}_{DS} = 400 \text{ V};$		-	54	-	ns
Q _r	recovered charge	T _j = 25 °C		-	276	-	nC
I _{rrm}	reverse recovery current			-	9	-	А





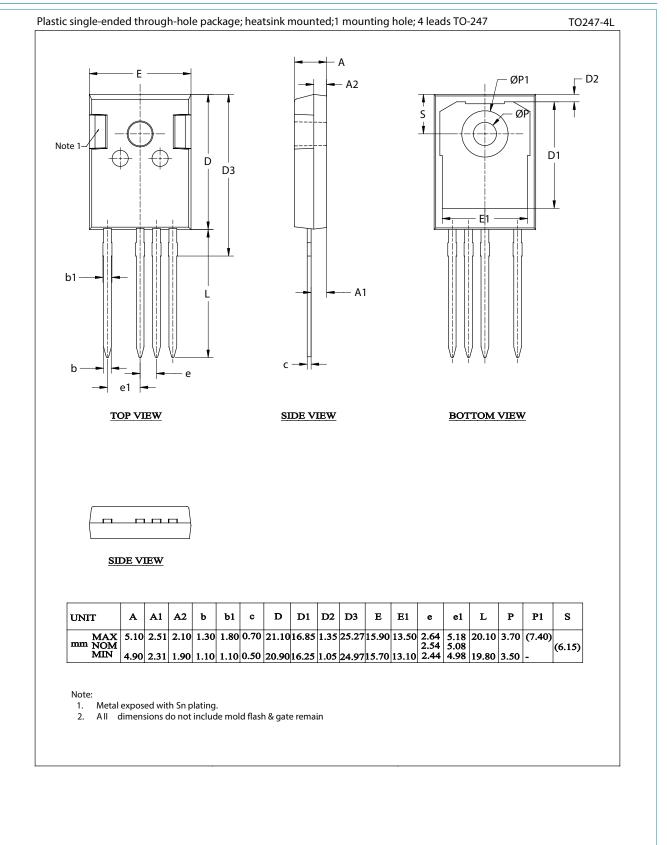






WNSC2M20120R N-Channel Silicon Carbide MOSFET

11. Package outline



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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